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FDD6530A

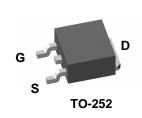
20V N-Channel PowerTrench[®] MOSFET Features

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low RDS(ON) and fast switching speed.

Applications

- DC/DC converter
- Motor drives

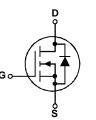




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• 21 A, 20 V $R_{DS(ON)} = 32 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$ $R_{DS(ON)} = 47 \text{ m}\Omega @ V_{GS} = 2.5 \text{ V}$

- Low gate charge (6.5 nC typical)
- · Fast switching
- High performance trench technology for extremely low $R_{\text{DS(ON)}}$



Absolute Maximum Ratings T_{A=25°C} unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		20	V
V _{GSS}	Gate-Source Voltage		±8	V
I _D	Drain Current – Continuous	(Note 3)	21	А
	– Pulsed	(Note 1a)	100	
P _D	Power Dissipation	(Note 1)	33	W
		(Note 1a)	3.3	
		(Note 1b)	1.6	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +175	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	4.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	45	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDD6530A	FDD6530A	13"	16mm	2500 units

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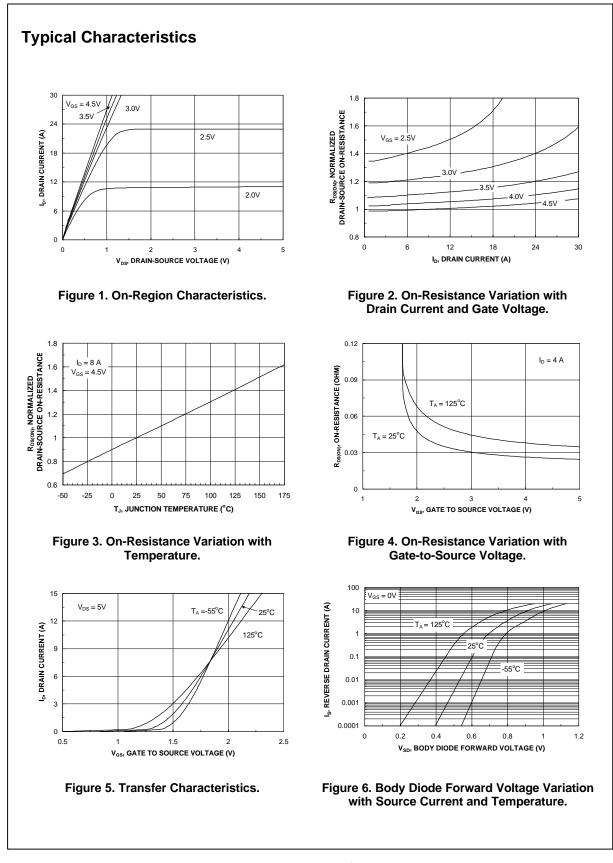
Drain-So	Parameter	Test Conditions	Min	Тур	Max	Units
	ource Avalanche Ratings (Note	∋ 2)				
W _{DSS}	Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 10 V$			55	mJ
AR	Drain-Source Avalanche Current				8	А
Off Char	acteristics	•	•			
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	20			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		15		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 16 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			-100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$	0.4	0.9	1.2	V
<u>ΔVgs(th)</u> ΔTj	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25° C		-3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance			26 36 36	32 47 48	mΩ
D(on)	On–State Drain Current		20			A
g _{FS}	Forward Transconductance	$V_{DS} = 5 \text{ V}, \qquad I_{D} = 8 \text{ A}$		21		S
Dynamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = 10 \text{ V}, \qquad V_{GS} = 0 \text{ V},$		710		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		173		pF
C _{rss}	Reverse Transfer Capacitance			84		pF
Switchin	g Characteristics (Note 2)					
d(on)	Turn–On Delay Time	$V_{DD} = 10 V$, $I_D = 1 A$,		8	16	ns
r	Turn–On Rise Time	$V_{GS} = 4.5 V$, $R_{GEN} = 6$		7	14	ns
d(off)	Turn–Off Delay Time			18	32	ns
f	Turn–Off Fall Time			4	8	ns
Qg	Total Gate Charge	$V_{DS} = 10 V$, $I_D = 8 A$,		6.5	9	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = 4.5 V$		1.3		nC
Q _{gd}	Gate–Drain Charge	1		1.9		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
	Maximum Continuous Drain–Source				2.7	А
s				0.8	1.2	14

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

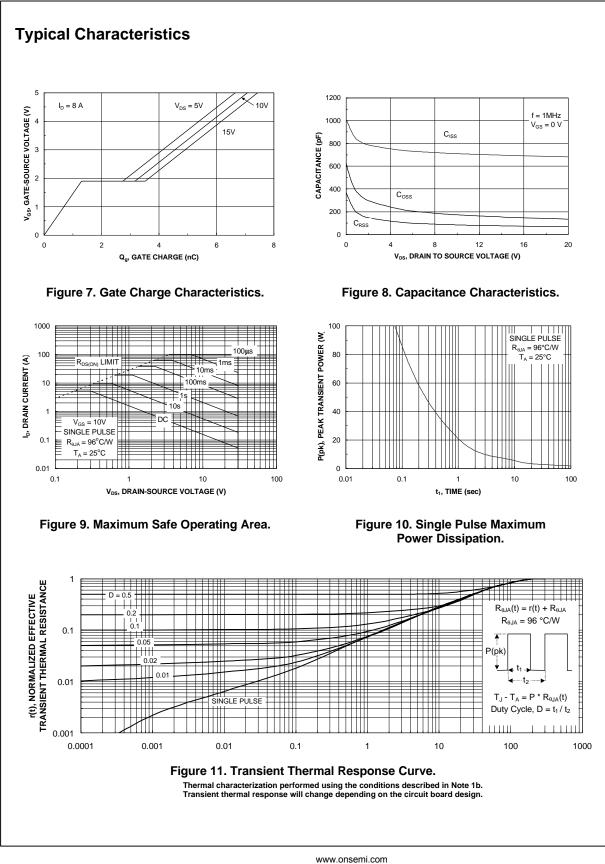
3. Maximum current is calculated as:

Maximum current is calculated as: $\sqrt{\frac{P_D}{P_{D-RicNAL}}}$ where P_D is maximum power dissipation at $T_C = 25^{\circ}C$ and $R_{DS(on)}$ is at $T_{J(max)}$ and $V_{GS} = 10V$. Package current limitation is 21A

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